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Details

Product Status	Active
Core Processor	12V1
Core Size	16-Bit
Speed	25MHz
Connectivity	IrDA, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	26
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3.13V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/s9s12gn16f1mlcr

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Figure 5-10.

Background Debug Module (S12SBDMV1)

If an interrupt is pending when a TRACE1 command is issued, the interrupt stacking operation occurs but no user instruction is executed. Once back in standard BDM firmware execution, the program counter points to the first instruction in the interrupt service routine.

Be aware when tracing through the user code that the execution of the user code is done step by step but all peripherals are free running. Hence possible timing relations between CPU code execution and occurrence of events of other peripherals no longer exist.

Do not trace the CPU instruction BGND used for soft breakpoints. Tracing over the BGND instruction will result in a return address pointing to BDM firmware address space.

When tracing through user code which contains stop or wait instructions the following will happen when the stop or wait instruction is traced:

The CPU enters stop or wait mode and the TRACE1 command can not be finished before leaving the low power mode. This is the case because BDM active mode can not be entered after CPU executed the stop instruction. However all BDM hardware commands except the BACKGROUND command are operational after tracing a stop or wait instruction and still being in stop or wait mode. If system stop mode is entered (all bus masters are in stop mode) no BDM command is operational.

As soon as stop or wait mode is exited the CPU enters BDM active mode and the saved PC value points to the entry of the corresponding interrupt service routine.

In case the handshake feature is enabled the corresponding ACK pulse of the TRACE1 command will be discarded when tracing a stop or wait instruction. Hence there is no ACK pulse when BDM active mode is entered as part of the TRACE1 command after CPU exited from stop or wait mode. All valid commands sent during CPU being in stop or wait mode or after CPU exited from stop or wait mode will have an ACK pulse. The handshake feature becomes disabled only when system stop mode has been reached. Hence after a system stop mode the handshake feature must be enabled again by sending the ACK_ENABLE command.

7.4.11 Serial Communication Time Out

The host initiates a host-to-target serial transmission by generating a falling edge on the BKGD pin. If BKGD is kept low for more than 128 target clock cycles, the target understands that a SYNC command was issued. In this case, the target will keep waiting for a rising edge on BKGD in order to answer the SYNC request pulse. If the rising edge is not detected, the target will keep waiting forever without any time-out limit.

Consider now the case where the host returns BKGD to logic one before 128 cycles. This is interpreted as a valid bit transmission, and not as a SYNC request. The target will keep waiting for another falling edge marking the start of a new bit. If, however, a new falling edge is not detected by the target within 512 clock cycles since the last falling edge, a time-out occurs and the current command is discarded without affecting memory or the operating mode of the MCU. This is referred to as a soft-reset.

If a read command is issued but the data is not retrieved within 512 serial clock cycles, a soft-reset will occur causing the command to be disregarded. The data is not available for retrieval after the time-out has occurred. This is the expected behavior if the handshake protocol is not enabled. In order to allow the data to be retrieved even with a large clock frequency mismatch (between BDM and CPU) when the hardware

Table 10-12	CPMUCOP	Field Descriptio	ns
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Field	Description
7 WCOP	 Window COP Mode Bit — When set, a write to the CPMUARMCOP register must occur in the last 25% of the selected period. A write during the first 75% of the selected period generates a COP reset. As long as all writes occur during this window, \$55 can be written as often as desired. Once \$AA is written after the \$55, the time-out logic restarts and the user must wait until the next window before writing to CPMUARMCOP. Table 10-13 shows the duration of this window for the seven available COP rates. 0 Normal COP operation 1 Window COP operation
6 RSBCK	COP and RTI Stop in Active BDM Mode Bit 0 Allows the COP and RTI to keep running in Active BDM mode. 1 Stops the COP and RTI counters whenever the part is in Active BDM mode.
5 WRTMASK	 Write Mask for WCOP and CR[2:0] Bit — This write-only bit serves as a mask for the WCOP and CR[2:0] bits while writing the CPMUCOP register. It is intended for BDM writing the RSBCK without changing the content of WCOP and CR[2:0]. Write of WCOP and CR[2:0] has an effect with this write of CPMUCOP Write of WCOP and CR[2:0] has no effect with this write of CPMUCOP. (Does not count for "write once".)
2–0 CR[2:0]	 COP Watchdog Timer Rate Select — These bits select the COP time-out rate (see Table 10-13 and Table 10-14). Writing a nonzero value to CR[2:0] enables the COP counter and starts the time-out period. A COP counter time-out causes a System Reset. This can be avoided by periodically (before time-out) initializing the COP counter via the CPMUARMCOP register. While all of the following four conditions are true the CR[2:0], WCOP bits are ignored and the COP operates at highest time-out period (2²⁴ cycles) in normal COP mode (Window COP mode disabled): COP is enabled (CR[2:0] is not 000) BDM mode active RSBCK = 0 Operation in Special Mode

Table 10-13. COP Watchdog Rates if COPOSCSEL1=0 (default out of reset)

CR2	CR1	CR0	COPCLK Cycles to Time-out (COPCLK is either IRCCLK or OSCCLK depending on the COPOSCSEL0 bit)
0	0	0	COP disabled
0	0	1	2 ¹⁴
0	1	0	2 ¹⁶
0	1	1	2 ¹⁸
1	0	0	2 ²⁰
1	0	1	2 ²²
1	1	0	2 ²³
1	1	1	2 ²⁴



Read: Anytime

Write: Anytime if APIFE=0. Else writes have no effect.



Field	Description
15-0 APIR[15:0]	Autonomous Periodical Interrupt Rate Bits — These bits define the time-out period of the API. See Table 10-20 for details of the effect of the autonomous periodical interrupt rate bits.

The period can be calculated as follows depending on logical value of the APICLK bit:

APICLK=0: Period = 2*(APIR[15:0] + 1) * ACLK Clock Period APICLK=1: Period = 2*(APIR[15:0] + 1) * Bus Clock period

NOTE

For APICLK bit clear the first time-out period of the API will show a latency time between two to three f_{ACLK} cycles due to synchronous clock gate release when the API feature gets enabled (APIFE bit set).

Table 10-20. Selectable Autonomous Periodical Interrupt Periods

APICLK	APIR[15:0]	Selected Period
0	0000	0.2 ms ¹
0	0001	0.4 ms ¹
0	0002	0.6 ms ¹
0	0003	0.8 ms ¹

12.3.2.12.2 Right Justified Result Data (DJM=1)



Figure 12-15. Right justified ATD conversion result register (ATDDRn)

Table 12-22 shows how depending on the A/D resolution the conversion result is transferred to the ATD result registers for right justified data. Compare is always done using all 12 bits of both the conversion result and the compare value in ATDDRn.

A/D resolution	DJM	conversion result mapping to ATDDR <i>n</i>
8-bit data	1	Result-Bit[7:0] = result, Result-Bit[11:8]=0000
10-bit data	1	Result-Bit[9:0] = result, Result-Bit[11:10]=00
12-bit data	1	Result-Bit[11:0] = result

Table 12-22. Conversion result mapping to ATDDRn

Analog-to-Digital Converter (ADC10B16CV2)

¹If only AN0 should be converted use MULT=0.

15.3.2.2 ATD Control Register 1 (ATDCTL1)

Writes to this register will abort current conversion sequence.

Module Base + 0x0001



Figure 15-4. ATD Control Register 1 (ATDCTL1)

Read: Anytime

Write: Anytime

Table 15-3. AIDCILI Field Descriptions	Table 15-3.	ATDCTL1	Field	Descriptions
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Field	Description
7 ETRIGSEL	External Trigger Source Select — This bit selects the external trigger source to be either one of the AD channels or one of the ETRIG3-0 inputs. See device specification for availability and connectivity of ETRIG3-0 inputs. If a particular ETRIG3-0 input option is not available, writing a 1 to ETRISEL only sets the bit but has no effect, this means that one of the AD channels (selected by ETRIGCH3-0) is configured as the source for external trigger. The coding is summarized in Table 15-5.
6–5 SRES[1:0]	A/D Resolution Select — These bits select the resolution of A/D conversion results. See Table 15-4 for coding.
4 SMP_DIS	 Discharge Before Sampling Bit No discharge before sampling. The internal sample capacitor is discharged before sampling the channel. This adds 2 ATD clock cycles to the sampling time. This can help to detect an open circuit instead of measuring the previous sampled channel.
3–0 ETRIGCH[3:0]	External Trigger Channel Select — These bits select one of the AD channels or one of the ETRIG3-0 inputs as source for the external trigger. The coding is summarized in Table 15-5.

SRES1	SRES0	A/D Resolution
0	0	8-bit data
0	1	10-bit data
1	0	Reserved
1	1	Reserved

Analog-to-Digital Converter (ADC10B16CV2)

19.4.2 PWM Channel Timers

The main part of the PWM module are the actual timers. Each of the timer channels has a counter, a period register and a duty register (each are 8-bit). The waveform output period is controlled by a match between the period register and the value in the counter. The duty is controlled by a match between the duty register and the counter value and causes the state of the output to change during the period. The starting polarity of the output is also selectable on a per channel basis. Shown below in Figure 19-16 is the block diagram for the PWM timer.



PWMEx

Figure 19-16. PWM Timer Channel Block Diagram

19.4.2.1 PWM Enable

Each PWM channel has an enable bit (PWMEx) to start its waveform output. When any of the PWMEx bits are set (PWMEx = 1), the associated PWM output signal is enabled immediately. However, the actual PWM waveform is not available on the associated PWM output until its clock source begins its next cycle due to the synchronization of PWMEx and the clock source. An exception to this is when channels are concatenated. Refer to Section 19.4.2.7, "PWM 16-Bit Functions" for more detail.

NOTE

The first PWM cycle after enabling the channel can be irregular.

RWU bit remains set and the receiver remains on standby until another idle character appears on the RXD pin.

Idle line wakeup requires that messages be separated by at least one idle character and that no message contains idle characters.

The idle character that wakes a receiver does not set the receiver idle bit, IDLE, or the receive data register full flag, RDRF.

The idle line type bit, ILT, determines whether the receiver begins counting logic 1s as idle character bits after the start bit or after the stop bit. ILT is in SCI control register 1 (SCICR1).

20.4.6.6.2 Address Mark Wakeup (WAKE = 1)

In this wakeup method, a logic 1 in the most significant bit (MSB) position of a frame clears the RWU bit and wakes up the SCI. The logic 1 in the MSB position marks a frame as an address frame that contains addressing information. All receivers evaluate the addressing information, and the receivers for which the message is addressed process the frames that follow. Any receiver for which a message is not addressed can set its RWU bit and return to the standby state. The RWU bit remains set and the receiver remains on standby until another address frame appears on the RXD pin.

The logic 1 MSB of an address frame clears the receiver's RWU bit before the stop bit is received and sets the RDRF flag.

Address mark wakeup allows messages to contain idle characters but requires that the MSB be reserved for use in address frames.

NOTE

With the WAKE bit clear, setting the RWU bit after the RXD pin has been idle can cause the receiver to wake up immediately.

20.4.7 Single-Wire Operation

Normally, the SCI uses two pins for transmitting and receiving. In single-wire operation, the RXD pin is disconnected from the SCI. The SCI uses the TXD pin for both receiving and transmitting.



Figure 20-30. Single-Wire Operation (LOOPS = 1, RSRC = 1)

Enable single-wire operation by setting the LOOPS bit and the receiver source bit, RSRC, in SCI control register 1 (SCICR1). Setting the LOOPS bit disables the path from the RXD pin to the receiver. Setting the RSRC bit connects the TXD pin to the receiver. Both the transmitter and receiver must be enabled (TE = 1 and RE = 1). The TXDIR bit (SCISR2[1]) determines whether the TXD pin is going to be used as an input (TXDIR = 0) or an output (TXDIR = 1) in this mode of operation.



Figure 23-2. 16-Bit Pulse Accumulator Block Diagram



Figure 23-3. Interrupt Flag Setting

16 KByte Flash Module (S12FTMRG16K1V1)



¹ Loaded from IFR Flash configuration field, during reset sequence.

All bits in the FSEC register are readable but not writable.

During the reset sequence, the FSEC register is loaded with the contents of the Flash security byte in the Flash configuration field at global address 0x3_FF0F located in P-Flash memory (see Table 24-4) as indicated by reset condition F in Figure 24-6. If a double bit fault is detected while reading the P-Flash phrase containing the Flash security byte during the reset sequence, all bits in the FSEC register will be set to leave the Flash module in a secured state with backdoor key access disabled.

Table 24-9. FSEC Field Descriptions

Field	Description
7–6 KEYEN[1:0]	Backdoor Key Security Enable Bits — The KEYEN[1:0] bits define the enabling of backdoor key access to the Flash module as shown in Table 24-10.
5–2 RNV[5:2]	Reserved Nonvolatile Bits — The RNV bits should remain in the erased state for future enhancements.
1–0 SEC[1:0]	Flash Security Bits — The SEC[1:0] bits define the security state of the MCU as shown in Table 24-11. If the Flash module is unsecured using backdoor key access, the SEC bits are forced to 10.

Table 24-10. Flash KEYEN States

KEYEN[1:0]	Status of Backdoor Key Access
00	DISABLED
01	DISABLED ¹
10	ENABLED
11	DISABLED

Preferred KEYEN state to disable backdoor key access.

Table 24-11. Flash Security States

SEC[1:0]	Status of Security
00	SECURED
01	SECURED ¹
10	UNSECURED
11	SECURED

¹ Preferred SEC state to set MCU to secured state.

Register	Error Bit	Error Condition
ACCERR FSTAT FPVIOL MGSTAT1 MGSTAT0		Set if CCOBIX[2:0] != 101 at command launch
		Set if command not available in current mode (see Table 25-27)
	ACCERR	Set if an invalid global address [17:0] is supplied see Table 25-3)
		Set if a misaligned phrase address is supplied (global address [2:0] != 000)
	FPVIOL	Set if the global address [17:0] points to a protected area
	MGSTAT1	Set if any errors have been encountered during the verify operation
	MGSTAT0	Set if any non-correctable errors have been encountered during the verify operation

Table 25-41. Program P-Flash Command Error Handling

25.4.6.6 Program Once Command

The Program Once command restricts programming to a reserved 64 byte field (8 phrases) in the nonvolatile information register located in P-Flash. The Program Once reserved field can be read using the Read Once command as described in Section 25.4.6.4. The Program Once command must only be issued once since the nonvolatile information register in P-Flash cannot be erased. The Program Once command must not be executed from the Flash block containing the Program Once reserved field to avoid code runaway.

CCOBIX[2:0]	FCCOB P	FCCOB Parameters		
000	0x07	Not Required		
001	Program Once phrase in	Program Once phrase index (0x0000 - 0x0007)		
010	Program Once	e word 0 value		
011	Program Once	e word 1 value		
100	Program Once	Program Once word 2 value		
101	Program Once	e word 3 value		

Table 25-42. Program Once Command FCCOB Requirements

Upon clearing CCIF to launch the Program Once command, the Memory Controller first verifies that the selected phrase is erased. If erased, then the selected phrase will be programmed and then verified with read back. The CCIF flag will remain clear, setting only after the Program Once operation has completed.

The reserved nonvolatile information register accessed by the Program Once command cannot be erased and any attempt to program one of these phrases a second time will not be allowed. Valid phrase index values for the Program Once command range from 0x0000 to 0x0007. During execution of the Program Once command, any attempt to read addresses within P-Flash will return invalid data.

CAUTION

The FCLKDIV register should never be written while a Flash command is executing (CCIF=0).

Table 26-7. FCLKDIV Field Descriptions

Field	Description
7 FDIVLD	Clock Divider Loaded 0 FCLKDIV register has not been written since the last reset 1 FCLKDIV register has been written since the last reset
6 FDIVLCK	 Clock Divider Locked FDIV field is open for writing FDIV value is locked and cannot be changed. Once the lock bit is set high, only reset can clear this bit and restore writability to the FDIV field in normal mode.
5–0 FDIV[5:0]	Clock Divider Bits — FDIV[5:0] must be set to effectively divide BUSCLK down to 1 MHz to control timed events during Flash program and erase algorithms. Table 26-8 shows recommended values for FDIV[5:0] based on the BUSCLK frequency. Please refer to Section 26.4.4, "Flash Command Operations," for more information.

BUSCLK Frequency (MHz)		FDIV[5:0]		BUSCLK I (M	FDIV[5:0]	
MIN ¹	MAX ²			MIN ¹	MAX ²	
1.0	1.6	0x00		16.6	17.6	0x10
1.6	2.6	0x01		17.6	18.6	0x11
2.6	3.6	0x02		18.6	19.6	0x12
3.6	4.6	0x03		19.6	20.6	0x13
4.6	5.6	0x04		20.6	21.6	0x14
5.6	6.6	0x05		21.6	22.6	0x15
6.6	7.6	0x06		22.6	23.6	0x16
7.6	8.6	0x07		23.6	24.6	0x17
8.6	9.6	0x08		24.6	25.6	0x18
9.6	10.6	0x09				
10.6	11.6	0x0A				
11.6	12.6	0x0B				
12.6	13.6	0x0C				
13.6	14.6	0x0D				
14.6	15.6	0x0E				
15.6	16.6	0x0F				

Table 26-8. FDIV values for various BUSCLK Frequencies

¹ BUSCLK is Greater Than this value.

² BUSCLK is Less Than or Equal to this value.

During the reset sequence, fields DPOPEN and DPS of the EEPROT register are loaded with the contents of the EEPROM protection byte in the Flash configuration field at global address 0x3_FF0D located in P-Flash memory (see Table 26-4) as indicated by reset condition F in Table 26-23. To change the EEPROM protection that will be loaded during the reset sequence, the P-Flash sector containing the EEPROM protection byte must be unprotected, then the EEPROM protection byte must be programmed. If a double bit fault is detected while reading the P-Flash phrase containing the EEPROM protection byte must be to leave the EEPROM protection byte must be programmed. If a double bit fault is detected while reading the P-Flash phrase containing the EEPROM protection byte must be memory fully protected.

Trying to alter data in any protected area in the EEPROM memory will result in a protection violation error and the FPVIOL bit will be set in the FSTAT register. Block erase of the EEPROM memory is not possible if any of the EEPROM sectors are protected.

Table 26-22. EEPROT	Field Descriptions
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Field	Description
7 DPOPEN	 EEPROM Protection Control Enables EEPROM memory protection from program and erase with protected address range defined by DPS bits Disables EEPROM memory protection from program and erase
5–0 DPS[5:0]	EEPROM Protection Size — The DPS[5:0] bits determine the size of the protected area in the EEPROM memory as shown in Table 26-23.

DPS[5:0]	Global Address Range	Protected Size	
000000	0x0_0400 – 0x0_041F	32 bytes	
000001	0x0_0400 - 0x0_043F	64 bytes	
000010	0x0_0400 – 0x0_045F	96 bytes	
000011	0x0_0400 – 0x0_047F	128 bytes	
000100	0x0_0400 - 0x0_049F	160 bytes	
000101	0x0_0400 – 0x0_04BF	192 bytes	
The Protection Size goes on enlarging in step of 32 bytes, for each DPS value increasing of one.			
101111 - to - 111111	0x0_0400 – 0x0_09FF	1,536 bytes	

Table 26-23. EEPROM Protection Address Range

48 KByte Flash Module (S12FTMRG48K1V1)



All bits in the FRSV7 register read 0 and are not writable.

26.4 Functional Description

26.4.1 Modes of Operation

The FTMRG48K1 module provides the modes of operation normal and special . The operating mode is determined by module-level inputs and affects the FCLKDIV, FCNFG, and EEPROT registers (see Table 26-27).

26.4.2 IFR Version ID Word

The version ID word is stored in the IFR at address $0x0_40B6$. The contents of the word are defined in Table 26-26.

[15:4]	[3:0]		
Reserved	VERNUM		

Table 26-26.	IFR	Version	ID	Fields
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96 KByte Flash Module (S12FTMRG96K1V1)

Register	Error Bit	Error Condition	
		Set if CCOBIX[2:0] != 010 at command launch	
		Set if command not available in current mode (see Table 28-27)	
	ACCERR	Set if an invalid global address [17:0] is supplied	
		Set if a misaligned word address is supplied (global address [0] != 0)	
FSTAT		Set if the requested section breaches the end of the EEPROM block	
	FPVIOL MGSTAT1	None	
		MGSTAT1 Set if any errors have been encountered during the read or if	
	MGSTAT0	Set if any non-correctable errors have been encountered during the read or if blank check failed.	

Table 28-61. Erase Verify EEPROM Section Command Error Handling

28.4.6.15 Program EEPROM Command

The Program EEPROM operation programs one to four previously erased words in the EEPROM block. The Program EEPROM operation will confirm that the targeted location(s) were successfully programmed upon completion.

CAUTION

A Flash word must be in the erased state before being programmed. Cumulative programming of bits within a Flash word is not allowed.

 Table 28-62. Program EEPROM Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters					
000	0x11	Global address [17:16] to identify the EEPROM block				
001	Global address [15:0] of word to be programmed					
010	Word 0 program value					
011	Word 1 program value, if desired					
100	Word 2 program value, if desired					
101	Word 3 program value, if desired					

Upon clearing CCIF to launch the Program EEPROM command, the user-supplied words will be transferred to the Memory Controller and be programmed if the area is unprotected. The CCOBIX index value at Program EEPROM command launch determines how many words will be programmed in the EEPROM block. The CCIF flag is set when the operation has completed.

192 KByte Flash Module (S12FTMRG192K2V1)

If a reset occurs while any Flash command is in progress, that command will be immediately aborted. The state of the word being programmed or the sector/block being erased is not guaranteed.

Field	Description		
1 DFDIE	 Double Bit Fault Detect Interrupt Enable — The DFDIE bit controls interrupt generation when a double bit fault is detected during a Flash block read operation. 0 DFDIF interrupt disabled 1 An interrupt will be requested whenever the DFDIF flag is set (see Section 31.3.2.8) 		
0 SFDIE	 Single Bit Fault Detect Interrupt Enable — The SFDIE bit controls interrupt generation when a single bit fault is detected during a Flash block read operation. 0 SFDIF interrupt disabled whenever the SFDIF flag is set (see Section 31.3.2.8) 1 An interrupt will be requested whenever the SFDIF flag is set (see Section 31.3.2.8) 		

Table 31-14. FERCNFG Field Descriptions

31.3.2.7 Flash Status Register (FSTAT)

The FSTAT register reports the operational status of the Flash module.

Offset Module Base + 0x0006



Figure 31-11. Flash Status Register (FSTAT)

¹ Reset value can deviate from the value shown if a double bit fault is detected during the reset sequence (see Section 31.6).

CCIF, ACCERR, and FPVIOL bits are readable and writable, MGBUSY and MGSTAT bits are readable but not writable, while remaining bits read 0 and are not writable.

Table 31-15. FSTAT Field Descriptions

Field	Description			
7 CCIF	 Command Complete Interrupt Flag — The CCIF flag indicates that a Flash command has completed. T CCIF flag is cleared by writing a 1 to CCIF to launch a command and CCIF will stay low until command completion or command violation. 0 Flash command in progress 1 Flash command has completed 			
5 ACCERR	Flash Access Error Flag — The ACCERR bit indicates an illegal access has occurred to the Flash memory caused by either a violation of the command write sequence (see Section 31.4.4.2) or issuing an illegal Flash command. While ACCERR is set, the CCIF flag cannot be cleared to launch a command. The ACCERR bit is cleared by writing a 1 to ACCERR. Writing a 0 to the ACCERR bit has no effect on ACCERR. 0 No access error detected 1 Access error detected			
4 FPVIOL	Flash Protection Violation Flag — The FPVIOL bit indicates an attempt was made to program or erase an address in a protected area of P-Flash or EEPROM memory during a command write sequence. The FPVIOL bit is cleared by writing a 1 to FPVIOL. Writing a 0 to the FPVIOL bit has no effect on FPVIOL. While FPVIOL is set, it is not possible to launch a command or start a command write sequence. 0 No protection violation detected 1 Protection violation detected			

A.1.8 Power Dissipation and Thermal Characteristics

Power dissipation and thermal characteristics are closely related. The user must assure that the maximum operating junction temperature is not exceeded. The average chip-junction temperature (T_J) in °C can be obtained from:

$$\mathsf{T}_{\mathsf{J}} = \mathsf{T}_{\mathsf{A}} + (\mathsf{P}_{\mathsf{D}} \bullet \Theta_{\mathsf{J}} \mathsf{A})$$

 T_{I} = Junction Temperature, [°C]

 $T_A = Ambient Temperature, [°C]$

P_D = Total Chip Power Dissipation, [W]

 Θ_{JA} = Package Thermal Resistance, [°C/W]

The total power dissipation can be calculated from:

$$P_D = P_{INT} + P_{IO}$$

P_{INT} = Chip Internal Power Dissipation, [W]

$$P_{IO} = \sum_{i} R_{DSON} \cdot I_{IO_{i}}^{2}$$

 P_{IO} is the sum of all output currents on I/O ports associated with V_{DDX} , whereby

$$R_{DSON} = \frac{V_{OL}}{I_{OL}}; \text{for outputs driven low}$$
$$R_{DSON} = \frac{V_{DD35} - V_{OH}}{I_{OH}}; \text{for outputs driven high}$$

 $P_{INT} = I_{DDR} \cdot V_{DDR} + I_{DDA} \cdot V_{DDA}$

Electrical Characteristics

Conditions are: Temperature option W (see Table A-4)								
Num	С	Rating	Symbol	Min	Тур	Max	Unit	
1	М	Internal Reference Frequency, factory trimmed	f _{IRC1M_TRIM}	0.987	1	1.013	MHz	